# 2SD2210

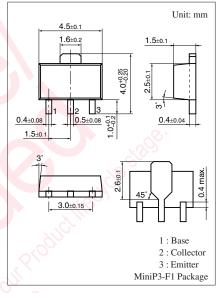
## Silicon NPN epitaxial planar type

For low-voltage output amplification For muting For DC-DC converter

#### Features

- $\bullet$  Low collector-emitter saturation voltage  $V_{\mbox{CE(sat)}}$
- Low ON resistance R<sub>on</sub>
- $\bullet$  High forward current transfer ratio  $h_{FE}$

Absolute Maximum Ratings $T_a = 25^{\circ}C$						
Parameter	Symbol	Symbol Rating				
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	25	V			
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	20	V			
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	12	V			
Collector current	I <sub>C</sub>	0.5	А			
Peak collector current	I <sub>CP</sub>	1	А			
Collector power dissipation *	P <sub>C</sub>	1	W			
Junction temperature	Tj	150	°C			
Storage temperature	T <sub>stg</sub>	-55 to +150	°C			



#### Marking Symbol: 1K

Note) \*: Printed circuit board: Copper foil area of 1 cm<sup>2</sup> or more, and the board thickness of 1.7 mm for the collector portion

#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_{\rm C} = 10 \ \mu A, I_{\rm E} = 0$	25	- Clip		V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_{C} = 1 \text{ mA}, I_{B} = 0$	20	S		V
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	$I_{\rm E} = 10 \ \mu A, I_{\rm C} = 0$	12			V
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{CB} = 25 V, I_E = 0$	0.7		1	μΑ
Forward current transfer ratio *1	h <sub>FE1</sub> *2	$V_{CE} = 2 V, I_C = 0.5 A$	200		800	
	h <sub>FE2</sub>	$V_{CE} = 2 V, I_C = 1 A$	60			
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = 500 \text{ mA}, I_{\rm B} = 20 \text{ mA}$		0.13	0.40	V
Base-emitter saturation voltage	V <sub>BE(sat)</sub>	$I_{\rm C} = 500 \text{ mA}, I_{\rm B} = 50 \text{ mA}$			1.2	V
Transition frequency	f <sub>T</sub>	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		200		MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		10		pF
(Common base, input open circuited)						
ON resistanse *3	R <sub>on</sub>			1		Ω

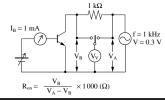
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*1: Pulse measurement

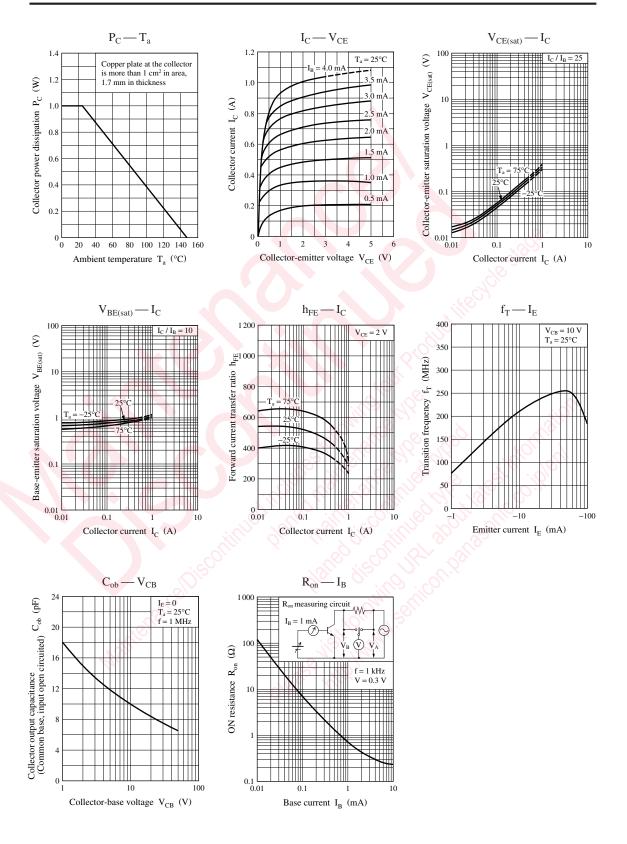
\*2: Rank classification

Rank	R	S	Т
h <sub>FE1</sub>	200 to 350	300 to 500	400 to 800

\*3: R<sub>on</sub> Measuremet circuit



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